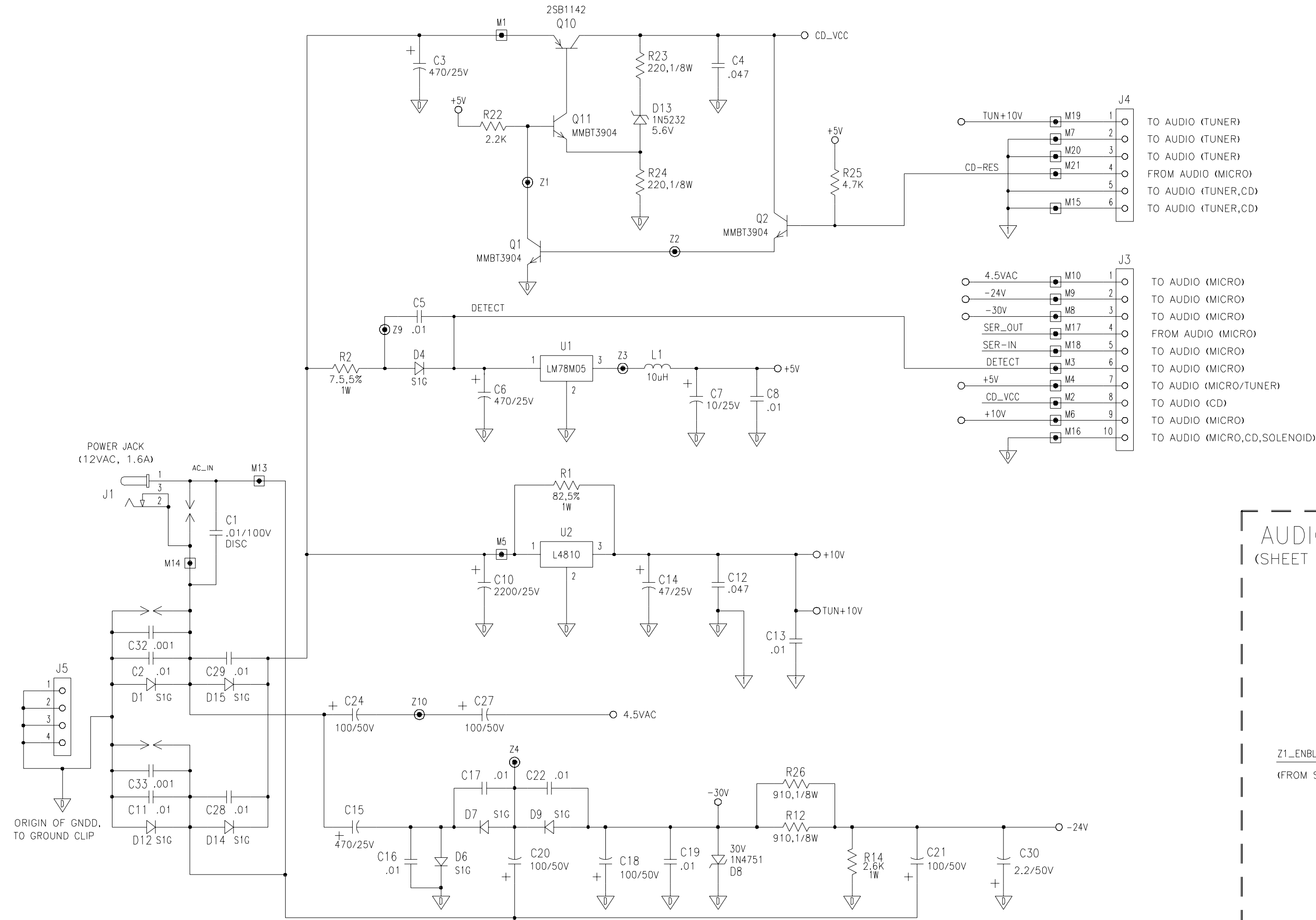


REVISIONS				
REV	DESCRIPTION	CHK	ENG	DATE
01	ECN 17806: DESIGN IMPROVEMENTS	HK	HK	4/24/95
02	ECN 17985: DESIGN IMPROVEMENTS	HK	HK	5/31/95
03	ECN 18152: DESIGN IMPROVEMENTS	HK	HK	6/27/95
04	ECN 18245: DESIGN IMPROVEMENTS	HK	HK	8/4/95
05	ECN 18548: DESIGN IMPROVEMENTS	HK	HK	9/6/95
06	ECN 19597: DESIGN IMPROVEMENTS	HK	HK	2/29/96
07	ECN 21661: DESIGN IMPROVEMENTS	HK	HK	3/24/97
08	ECN 22843: DESIGN IMPROVEMENTS	HK	HK	10/21/97



- NOTES:
- UNLESS OTHERWISE SPECIFIED:
1. ALL RESISTORS ARE EXPRESSED IN OHMS AND ARE 1/10W, 5%.
 2. ALL CAPACITORS ARE EXPRESSED IN MICROFARADS.
 3. ALL CAPACITORS ARE CERAMIC CHIPS.
 4. CERAMIC CHIP CAPACITORS LESS THAN 1000P ARE COG.
CERAMIC CHIP CAPACITORS BETWEEN 1000P AND .033uF ARE X7R.
CERAMIC CHIP CAPACITORS BETWEEN .033uF AND .068uF ARE Z5U.
CERAMIC CHIP CAPACITORS GREATER THAN .068uF ARE Y5U.
 5. LM393 (8 PIN): +V IS PIN 8, GND IS PIN 4.
 6. \diamond DENOTES TEST POINTS FOR FIELD SERVICE OR ENGINEERING.
 7. \blacksquare DENOTES FUNCTIONAL TEST POINTS.
 8. \bullet DENOTES TEST POINTS FOR I.C.T. (ZENTHEL).
 9. ALL DIODES ARE MMBD914LT1.
 10. SEE SHEETS 3 AND 4 FOR COUNTRY VERSION AND OPTION INFO.

SUPPLY BOARD

THIS DRAWING IS BASED ON
P-CAD DATA. ALL CHANGES
MUST BE MADE USING THE
P-CAD FILES ATTACHED TO
MD178335.

THIRD ANGLE PROJECTION		LEVEL	DRAFTER	DATE
		3		2/24/95
UNLESS OTHERWISE SPECIFIED INTERPRET THIS DRAWING PER ANSI Y14.3M-1982		2	CHECKER	2/24/95
NOTICE		1	ENGINEER	2/24/95
BOSE CORP. PROPRIETARY RIGHTS ARE INCLUDED HEREIN. THIS INFORMATION MAY NOT BE COPIED, TRANSMITTED OR DISCLOSED EXCEPT AS AUTHORIZED BY BOSE CORP.			SAFETY ENGINEER	2/24/95
			REL TO PROD PER ECN# 19597 AT REV 6	2/29/96

SAFETY CONTROLLED				
FRAMINGHAM, MA 01701-9168				
TITLE				
PC BOARD, CD-20				
SIZE	FSCM	CLASS	DWG NO.	REV
C	32108	SD	178335	08
SCALE: NONE		CAT. CODE		SHEET 1 OF 5

